DOCUMENT: M20016 REV LETTER: H PAGE NO: 1 OF 2 REV DATE: 2019-09-25 PART NUMBER:

# Polymer PTC Devices

# Wayon Electronics Co., Ltd.

PTC DevicesNo.1001,Shiwan 7th Road,Pudong,Shanghai 201202,P.R.China<br/>Tel: 86-21-50968309Surface mount fusesE-mail: market@way-on.comHttp://www.way-on.com

**WAY ØN** 

## LP-TSM004

#### Features

- Small size of 0603
- Lead-free and compliant with the European Union RoHS Directive 2011/65/EU
- Fast tripping resettable circuit protection
- Surface mount packaging for automated assembly
- Agency Recognition: UL、TUV

### **Product Dimensions (mm)**

Part number	Α	В	С	D
	Max.	Max.	Max.	Min.
LP-TSM004	1.80	1.00	0.75	0.15

c SU<sup>°</sup>us

#### **Electrical Characteristics**

Part number –	I <sub>H</sub>	Ι <sub>Τ</sub>	V <sub>max</sub>	I <sub>max</sub>	T <sub>trip</sub>		Pd <sub>typ</sub>	$R_{min}$	R <sub>1max</sub>
	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	<b>(</b> Ω)	<b>(</b> Ω)
LP-TSM004	0.04	0.12	15.0	3.5	0.20	1.00	0.5	4.000	40.000

 $I_{H}\!\!=\!\!$  Hold current: maximum current at which the device will not trip at 25  $^\circ\!\!\mathbb{C}$  still air.

 $I_{T}\text{=}\text{Trip}$  current: minimum current at which the device will always trip at 25  $^{\circ}\!\mathrm{C}$  still air.

V<sub>max</sub>=Maximum voltage device can withstand without damage at rated current.

I<sub>max</sub>=Maximum fault current device can withstand without damage at rated voltage.

T<sub>trip</sub>=Maximum time to trip(s) at assigned current.

Pd<sub>tvp</sub>=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

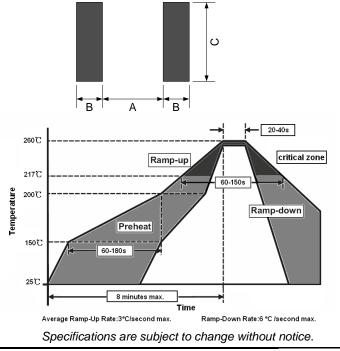
R<sub>min</sub>=Minimum device resistance at 25°C prior to tripping.

R<sub>1max</sub>=Maximum device resistance measured in the nontripped state 1 hour post reflow.

### **Thermal Derating**

LP-TSM004	Maximum ambient operating temperature(℃)									
	-40	-20	0	20	25	40	50	60	70	85
Hold Current (A)	0.052	0.048	0.044	0.041	0.040	0.032	0.028	0.024	0.020	0.012
Trip Current (A)	0.156	0.144	0.132	0.123	0.120	0.096	0.084	0.072	0.060	0.036

### Solder Reflow Recommendations



Solder Pad Layouts					
Part number	Α	С			
	(mm)	(mm)	(mm)		
LP-TSM004	0.60	1.10	1.00		

\* Recommended reflow methods: IR, Vapor phase, hot air oven.

\* Devices can be cleaned using standard industry methods and solvents.

Notes:

• If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

• Devices are not designed to be wave soldered to the bottom side of the board.

#### Package Information

Tape & Reel:5000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame. Specifications are subject to change without notice.

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LP-TSM004

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		Surface mount fuses	E-mail: market@way-on.com	Http://www.way-on.com	
-1	SM004				
			SMD PTC 使用注意	事	
			Cautions for SMD PT		
1.	连左 切 枚 廿 廿			● 050 或最大电流规格值的操作,可能会导致 PTC 出现□	ш
1.		而走的取入电压和取入电加 高,甚至烧片。	L下使用,超出 <b>FIC</b> 取入电压.	或取入电视观俗值的操作,可能云寻致 <b>FIC</b> 面现,	巴
			ne or current may result in de	vice damage, PTC arcing, resistance increasing,	
	even burning	,			
2.	规格书所规定	E的各温度下的 Hold curre	nt 均是 PTC 经过一次回流焊	接得出的常规性能,PTC 能够在不同温度对应的电	包
			致型号 PTC 能够适用的长期充		
				et is the conventional performance of after one	
				o different temperatures. But this current is not the	е
3.			scharging current for long time	z. 过一次回流焊之后的测试。如果客户有二次回流焊重	武
0.			数有一定程度的衰减。所以需		-24
				isheet are based on the test tested on the specifie	эd
				eds to be verified because above parameters ma	
			ocesses, like twice soldering		
4.				热源元件,尽量减少外部热源的影响。	
		utside heat source impact		urce devices be designed to around in order to	
5.				焊接工艺可参考维安推荐的回流焊曲线。如果回流	流
•				PTC,禁止对线路板其他元件或端子返工时使用热	
	风枪。				
				Please refer to the Wayon recommended	
				nded value, the PTC might be damaged. Manua	зI
				ework of other components on the board.	
6.				化胶粘剂、硅胶,需要对注塑料胶料等材料牌号以	Y
				已性,确认不会影响 PTC 性能之后方可使用。	,
				ation parameters (Temperature, Time, and etc.) of ould be verified to ensure the consistency betwee	
				at would not influent PTC then can be used.	
7.				如必须使用,需要验证各类清洗剂、洗板水以及;	溶
	剂的适用性,	确认不会影响 PTC 性能	之后方可使用。已知对 PTC 有	f影响的化学药品包括但不仅限于醚类、苯类、酮素	类
		交强溶解性、破坏性的有机	l化合物。清洗后将产品放置于	一敞开的环境中至少24小时,将残留的溶剂进行充	ž
	分的挥发。				
i c				sing washer water or other cleaner to clean PTC. aner, washer water and solvents, it is also	lf
				that are known to have an effect on PTC include	۷
				ounds such as ethers, benzenes, ketones, and	',
	lipids. Placin	g the product in open env	rironment for at least 24 hours	s to volatilize the residual solvents.	
8.				本体,以免引起 PTC 性能衰减。	
		• • •	it, twist and etc. to PTC during	g assembling process to avoid the performance	
9.	degradation. 在产品应用d		加雪江朔武打防 须在尽量等	豆的时间内完成,如贴装与注塑打胶时间间隔超过	· 1
5.		了,「ICFIG生候」。 资闭保存,可避免 PTC 长时		亚的时间内元成,如如农马社至11成时间间隔起足	. •
				the injection or glue as soon as possible. IF the	
	time lag betw	veen the injection and glu		eeds to reserve in the closed space so as to avoid	
		to the air too long.			
10.			故开关使用,重复多次的保护会。 Il pot bound op quittab。Tho		
	r i o is leset	iable protector, which sha	in not be used as switch. The	hold current will reduced after repeated tripping.	

11. PTC 在充电线端应用中,建议使用 PP 类材料做内膜,禁止使用 TPE 类与 PVC 类等材料做内膜。 If PTC applied in the charging terminal, the PP material is recommended as inner membrane, TPE or PVC materials are prohibited.

12. 维安 SMD PTC 湿敏等级为 1 级,为密封包装。客户如在库存中发现有包装破损的,立即将产品隔离处理;使用时如有 余料, 需恢复之前包装状态, 做密封保存

The MSL level of SMD PTC is 1, which is sealed packed. If any damaged package is found by customer, please isolate them. If there is rest parts, needs repack it as the previous package and reserve hermetically.

单击下面可查看定价,库存,交付和生命周期等信息

>>WAY-ON(维安)